

FTSH-125-01-L-DV-EJ



FTSH-110-01-L-DV  
FTSH-120-01-F-DV

(1.27 mm) .050"

# SMT MICRO HEADER

## SPECIFICATIONS

For complete specifications and recommended PCB layouts see [www.samtec.com?FTSH](http://www.samtec.com?FTSH)

**Insulator Material:** Black Liquid Crystal Polymer  
**Terminal Material:** Phosphor Bronze  
**Plating:** Sn or Au over 50 μm (1.27 μm) Ni  
**Current Rating (FTSH/CLP):** 3.4 A per pin (2 pins powered)  
**Operating Temp Range:** -55 °C to +125 °C  
**RoHS Compliant:** Yes

## PROCESSING

**Lead-Free Solderable:** Yes  
**SMT Lead Coplanarity:**  
 -MT & -DV Tail Option: (0.10 mm) .004" max (02-25)  
 -MT & -DH Tail Option: (0.15 mm) .006" max (26-50)\*  
 \*(.004" stencil solution may be available; contact [IPG@samtec.com](mailto:IPG@samtec.com))

## RECOGNITIONS

For complete scope of recognitions see [www.samtec.com/quality](http://www.samtec.com/quality)



## ALSO AVAILABLE (MOQ Required)

- Molded Pick & Place pads
  - Latches
  - Other platings
- Contact Samtec.

**Notes:**  
 Some sizes, styles and options are non-standard, non-returnable.

See SFM/TFM for positive alignment feature.

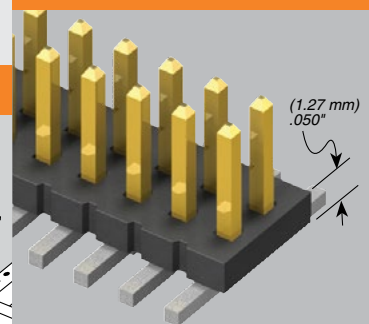
**Board Mates:** CLP, FLE

**Cable Mates:** FFSD, FFTP

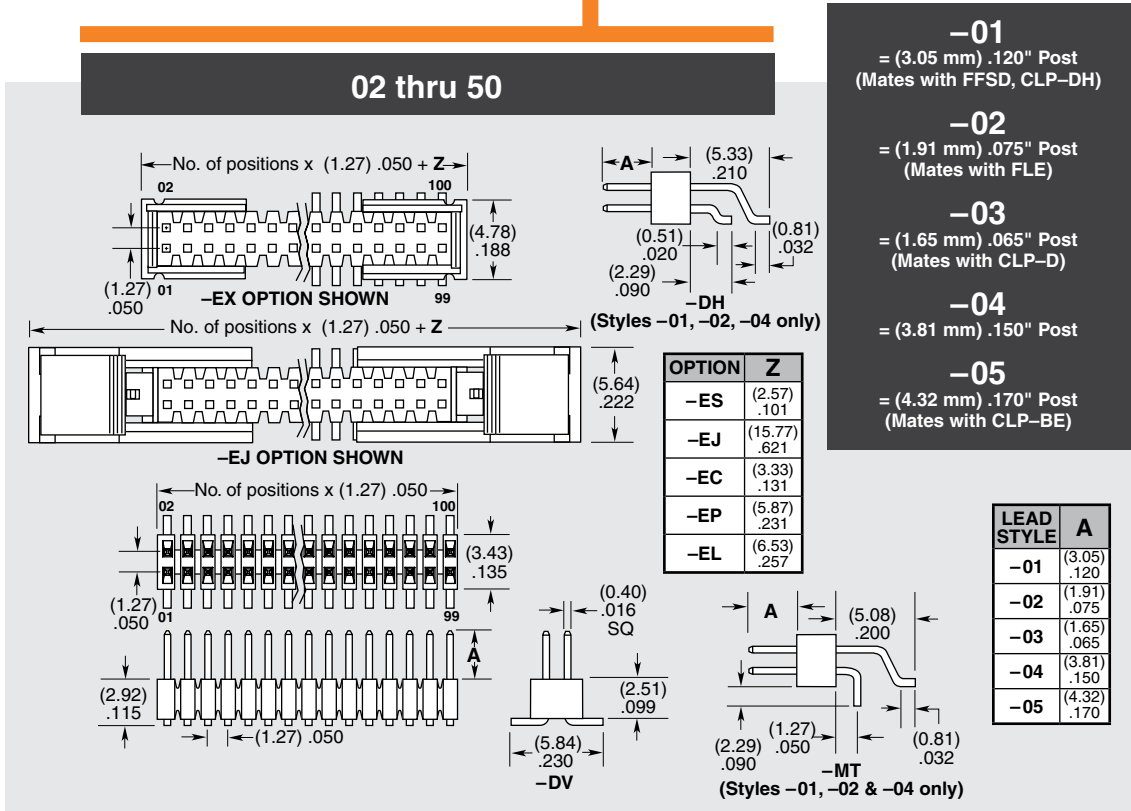
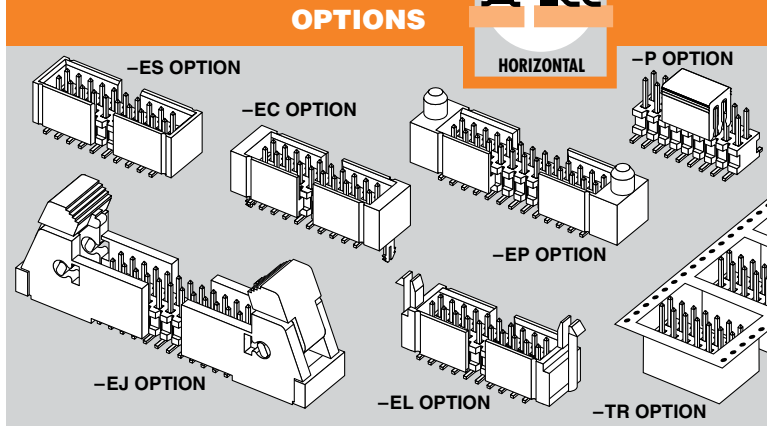
## APPLICATIONS



## OTHER SOLUTIONS



Ultra-low profile option available. End Shrouds available. Call for FTS Series specifications.



Due to technical progress, all designs, specifications and components are subject to change without notice.

FTSH-116-02-L-DV

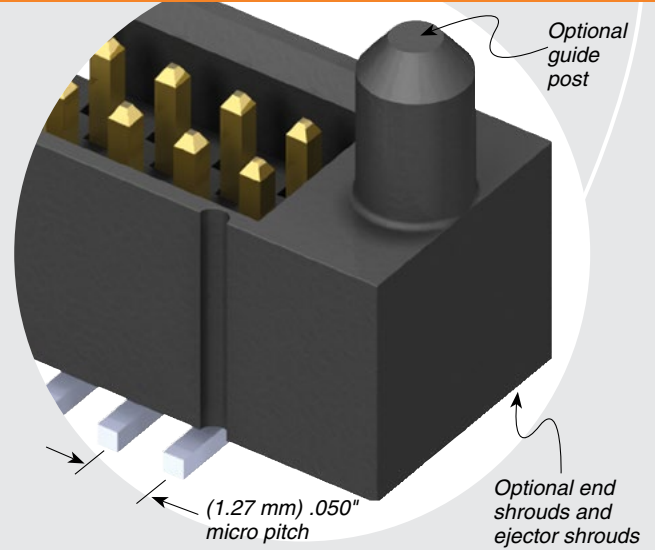
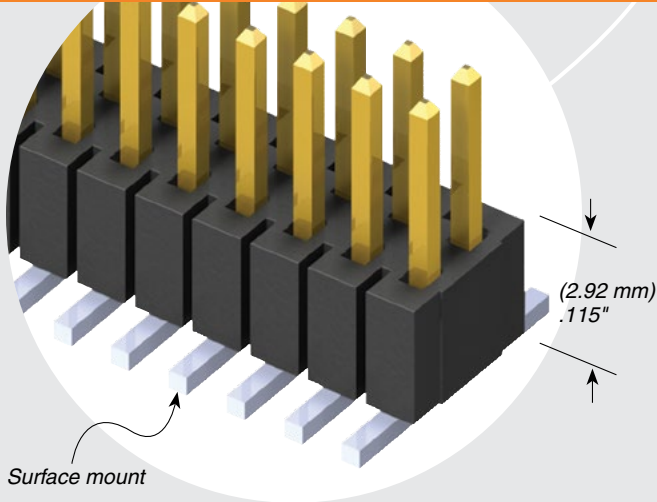
FTSH-110-01-F-DV

FTSH-112-02-L-DH

FTSH-116-03-L-DV-EP-P

FTSH-130-02-L-DV-EP

**FTSH SERIES**



**PLATING OPTION**

- F**  
= Gold flash on post, Matte Tin on tail
- L**  
= 10 μm (0.25 μm) Gold on post, Matte Tin on tail

**TAIL OPTION**

- DV**  
= Double Vertical
- DH**  
= Double Horizontal (Styles -01, -02 & -04 only)
- MT**  
= Mixed Technology (Styles -01, -02 & -04 only)

**OPTION**

- Leave Blank for -DH & -MT
- “XXX”**  
= Polarized Position (Specify position of omitted pin) (Not available with -EX options)

**FLEX SHROUD OPTIONS**

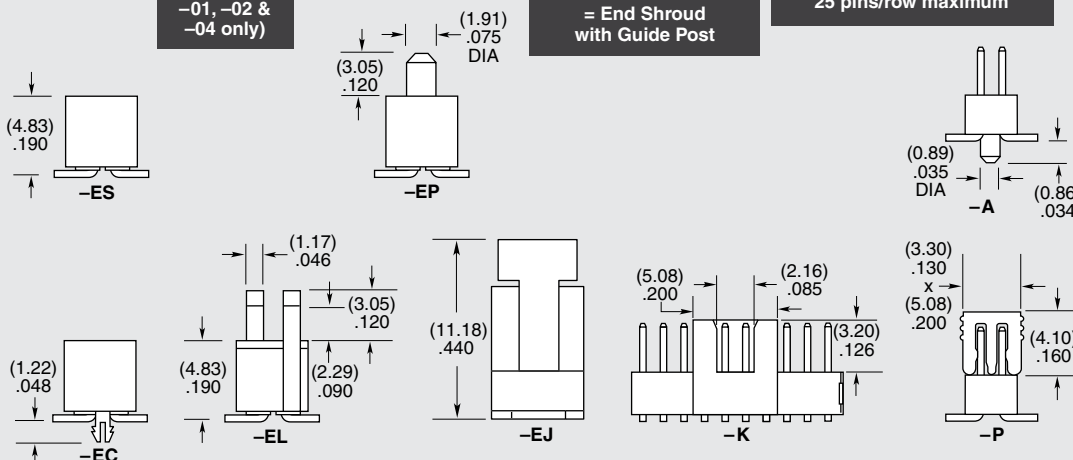
(Style -02 & -03 only, -DH & -MT not available)  
9 pins/row minimum  
(Other positions available. Call Samtec.)

- ES**  
= End Shroud
- EC**  
= End Shroud with Locking Clip (Manual placement required)
- EP**  
= End Shroud with Guide Post

- EL**  
= End Shroud with Board Lock (Boards are positively locked and cannot be unmated)
- EJ**  
= Ejector Shroud (Style -01 only)  
-DH & -MT not available  
10 pins/row minimum  
25 pins/row maximum

**OTHER OPTIONS**

- K**  
= Keying Shroud (For mating with FFSD Style -01 only and 05, 08, 10, 13, 17, 20 & 25 pins/row only. 13, 17, 20 & 25 pins/row only with -EJ option) (-DV only)
- A**  
= Alignment Pin (-DV 3 positions min.) (-DH 5 positions min.) (Metal or plastic at Samtec discretion)
- C**  
= (5.00 mm) .197" DIA Polyimide film Pick & Place Pad (-DH only)
- P**  
= Pick & Place Pad (-DV 4 positions min.) (-DH & -MT not available)
- TR**  
= Tape & Reel Packaging (Flex Shroud options not available except -ES & -EJ)



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[WWW.SAMTEC.COM](http://WWW.SAMTEC.COM)

All parts within this catalog are built to Samtec's specifications. Customer specific requirements must be approved by Samtec and identified in a Samtec customer-specific drawing to apply.